



Kingston Technology FURY Renegade Pro módulo de memoria 32 GB 1 x 32 GB DDR5 ECC

Marca : Kingston Technology Familia de productos: FURY Código del producto: KF560R32RBE-32

Nombre del producto : 32GB
6000MT/s DDR5 ECC Reg CL32
DIMM FURY Renegade Pro EXPO

- Sobreaceleración con ECC
 - Mayor eficacia
 - Homologación Intel® XMP 3.0
 - Certificación AMD EXPO™
- 32GB 6000MT/s DDR5 ECC Reg CL32 DIMM FURY Renegade Pro EXPO

Kingston Technology FURY Renegade Pro módulo de memoria 32 GB 1 x 32 GB DDR5 ECC:

Sobreaceleración con ECC
Mantiene la integridad de los datos trascendiendo los límites del rendimiento DDR5.

Mayor eficacia
Con el doble de bancos y de velocidades de ráfaga, satisface las demandas de los programas y aplicaciones más recientes con una mayor eficacia y menores latencias.

Homologación Intel® XMP 3,0
Seleccione alguno de los perfiles integrados para maximizar el rendimiento de la memoria con avanzadas temporizaciones, velocidades y tensiones preoptimizadas.

AMD EXPO (Extended Profiles for Overclocking)
Entre los módulos certificados se incluyen los perfiles Intel XMP 3.0, lo que facilita la compatibilidad con la plataforma que elijas.

Plug N Play**
Los módulos Kingston FURY Renegade Pro DDR5 RDIMM se sobreaceleran automáticamente hasta la velocidad de referencia más alta.

Features		Features	
Buffered memory type	Registered (buffered)	Lead plating	Gold
On-Die ECC	✓	JEDEC standard	✓
CAS latency	32	Operational conditions	
Internal memory *	32 GB	Operating temperature (T-T)	0 - 95 °C
Memory layout (modules x size) *	1 x 32 GB	Storage temperature (T-T)	-55 - 100 °C
Internal memory type *	DDR5	Technical details	
Memory data transfer rate	6000 MT/s	Compliance certificates	RoHS
Component for *	PC/Server	Sustainability	
Memory form factor *	288-pin DIMM	Sustainability compliance	✓
ECC *	✓	Doesn't contain	Halogen
Memory channels	Dual-channel	Weight & dimensions	
Memory ranking	1	Width	3.8 mm
Memory voltage	1.35 V	Depth	133.3 mm
Module configuration	4096M x 80	Height	31.2 mm
Row cycle time	48 ns	Weight	21.7 g
Refresh row cycle time	295 ns	Packaging data	
Row active time	32 ns	Package width	57.1 mm
AMD Extended Profiles for Overclocking (EXPO)	✓	Package depth	14 mm
AMD Extended Profiles for Overclocking (EXPO) version	1.1	Package height	171.4 mm
SPD profile	✓	Package weight	34.72 g
Programming power voltage (VPP)	1.8 V	Logistics data	
Country of origin	China, Taiwan	Master (outer) case width	196.8 mm
Product colour	Black		

Features		Logistics data	
Cooling type	Heatsink	Master (outer) case length	311.1 mm
		Master (outer) case height	61 mm
		Master (outer) case gross weight	1.15 kg
		Products per master (outer) case	25 pc(s)



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